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PATENT APPLICATION

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	Kumar et al.	Group Art Unit:	1762
Serial No.:	09/903,114	Docket No.:	FSI0006/US/2
Filed:	July 11, 2001		
For:	THERMAL PROCESSING SYSTEM AND METHODS FOR FORMING LOW-K DIELECTRIC FILMS SUITABLE FOR INCORPORATION INTO MICRO- ELECTRONIC DEVICES		

Commissioner for Patents
Washington, DC 20231

I CERTIFY THAT ON Feb 22, 2002, THIS PAPER IS
BEING DEPOSITED WITH THE U.S. POSTAL SERVICE AS FIRST
CLASS MAIL IN AN ENVELOPE ADDRESSED TO THE
COMMISSIONER FOR PATENTS, WASHINGTON, DC 20231

Paula J. Breeden
PAULA BREEDEN

REQUEST FOR EXTENSION OF TIME UNDER 37 CFR 1.136(a)

Commissioner for Patents
Washington, DC 20231

Dear Sir:

Applicants respectfully petition the Commissioner for Patents to extend the time for response to the Notice to File Missing Parts of Nonprovisional Application mailed August 24, 2001, for four months from October 24, 2001, to February 24, 2002.

Enclosed is a check that includes the \$1,440.00 fee. Please charge any additional fees to Deposit Account No. 50-1775.

Respectfully submitted,

Feb 22, 2002
Date

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